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### Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications,

#### Details

Product Status	Active
Number of LABs/CLBs	448
Number of Logic Elements/Cells	4032
Total RAM Bits	294912
Number of I/O	195
Number of Gates	200000
Voltage - Supply	1.14V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	256-LBGA
Supplier Device Package	256-FTBGA (17x17)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/xilinx/xc3s200a-4ft256c">https://www.e-xfl.com/product-detail/xilinx/xc3s200a-4ft256c</a>



**Table 12: DC Characteristics of User I/Os Using Single-Ended Standards**

IOSTANDARD Attribute	Test Conditions		Logic Level Characteristics		
	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)	V <sub>OL</sub> Max (V)	V <sub>OH</sub> Min (V)	
LVTTL <sup>(3)</sup>	2	2	-2	0.4	2.4
	4	4	-4		
	6	6	-6		
	8	8	-8		
	12	12	-12		
	16	16	-16		
	24	24	-24		
LVCMOS33 <sup>(3)</sup>	2	2	-2	0.4	V <sub>CCO</sub> - 0.4
	4	4	-4		
	6	6	-6		
	8	8	-8		
	12	12	-12		
	16	16	-16		
	24 <sup>(4)</sup>	24	-24		
LVCMOS25 <sup>(3)</sup>	2	2	-2	0.4	V <sub>CCO</sub> - 0.4
	4	4	-4		
	6	6	-6		
	8	8	-8		
	12	12	-12		
	16 <sup>(4)</sup>	16	-16		
	24 <sup>(4)</sup>	24	-24		
LVCMOS18 <sup>(3)</sup>	2	2	-2	0.4	V <sub>CCO</sub> - 0.4
	4	4	-4		
	6	6	-6		
	8	8	-8		
	12 <sup>(4)</sup>	12	-12		
	16 <sup>(4)</sup>	16	-16		
LVCMOS15 <sup>(3)</sup>	2	2	-2	0.4	V <sub>CCO</sub> - 0.4
	4	4	-4		
	6	6	-6		
	8 <sup>(4)</sup>	8	-8		
	12 <sup>(4)</sup>	12	-12		
LVCMOS12 <sup>(3)</sup>	2	2	-2	0.4	V <sub>CCO</sub> - 0.4
	4 <sup>(4)</sup>	4	-4		
	6 <sup>(4)</sup>	6	-6		

**Table 12: DC Characteristics of User I/Os Using Single-Ended Standards(Continued)**

IOSTANDARD Attribute	Test Conditions		Logic Level Characteristics	
	I <sub>OL</sub> (mA)	I <sub>OH</sub> (mA)	V <sub>OL</sub> Max (V)	V <sub>OH</sub> Min (V)
PCI33_3 <sup>(5)</sup>	1.5	-0.5	10% V <sub>CCO</sub>	90% V <sub>CCO</sub>
PCI66_3 <sup>(5)</sup>	1.5	-0.5	10% V <sub>CCO</sub>	90% V <sub>CCO</sub>
HSTL_I <sup>(4)</sup>	8	-8	0.4	V <sub>CCO</sub> - 0.4
HSTL_III <sup>(4)</sup>	24	-8	0.4	V <sub>CCO</sub> - 0.4
HSTL_I_18	8	-8	0.4	V <sub>CCO</sub> - 0.4
HSTL_II_18 <sup>(4)</sup>	16	-16	0.4	V <sub>CCO</sub> - 0.4
HSTL_III_18	24	-8	0.4	V <sub>CCO</sub> - 0.4
SSTL18_I	6.7	-6.7	V <sub>TT</sub> - 0.475	V <sub>TT</sub> + 0.475
SSTL18_II <sup>(4)</sup>	13.4	-13.4	V <sub>TT</sub> - 0.603	V <sub>TT</sub> + 0.603
SSTL2_I	8.1	-8.1	V <sub>TT</sub> - 0.61	V <sub>TT</sub> + 0.61
SSTL2_II <sup>(4)</sup>	16.2	-16.2	V <sub>TT</sub> - 0.81	V <sub>TT</sub> + 0.81
SSTL3_I	8	-8	V <sub>TT</sub> - 0.6	V <sub>TT</sub> + 0.6
SSTL3_II	16	-16	V <sub>TT</sub> - 0.8	V <sub>TT</sub> + 0.8

#### Notes:

- The numbers in this table are based on the conditions set forth in [Table 8](#) and [Table 11](#).
- Descriptions of the symbols used in this table are as follows:  
 I<sub>OL</sub> — the output current condition under which V<sub>OL</sub> is tested  
 I<sub>OH</sub> — the output current condition under which V<sub>OH</sub> is tested  
 V<sub>OL</sub> — the output voltage that indicates a Low logic level  
 V<sub>OH</sub> — the output voltage that indicates a High logic level  
 V<sub>CCO</sub> — the supply voltage for output drivers  
 V<sub>TT</sub> — the voltage applied to a resistor termination
- For the LVCMOS and LVTTL standards; the same V<sub>OL</sub> and V<sub>OH</sub> limits apply for the Fast, Slow, and QUIETIO slew attributes.
- These higher-drive output standards are supported only on FPGA banks 1 and 3. Inputs are unrestricted. See the chapter "Using I/O Resources" in [UG331](#).
- Tested according to the relevant PCI specifications. For information on PCI IP solutions, see [www.xilinx.com/pci](http://www.xilinx.com/pci). The PCIX IOSTANDARD is available and has equivalent characteristics but no PCI-X IP is supported.

## Using IBIS Models to Simulate Load Conditions in Application

IBIS models permit the most accurate prediction of timing delays for a given application. The parameters found in the IBIS model ( $V_{REF}$ ,  $R_{REF}$ , and  $V_{MEAS}$ ) correspond directly with the parameters used in [Table 27](#) ( $V_T$ ,  $R_T$ , and  $V_M$ ). Do not confuse  $V_{REF}$  (the termination voltage) from the IBIS model with  $V_{REF}$  (the input-switching threshold) from the table. A fourth parameter,  $C_{REF}$ , is always zero. The four parameters describe all relevant output test conditions. IBIS models are found in the Xilinx development software as well as at the following link:

[www.xilinx.com/support/download/index.htm](http://www.xilinx.com/support/download/index.htm)

Delays for a given application are simulated according to its specific load conditions as follows:

1. Simulate the desired signal standard with the output driver connected to the test setup shown in [Figure 9](#). Use parameter values  $V_T$ ,  $R_T$ , and  $V_M$  from [Table 27](#).  $C_{REF}$  is zero.
2. Record the time to  $V_M$ .
3. Simulate the same signal standard with the output driver connected to the PCB trace with load. Use the appropriate IBIS model (including  $V_{REF}$ ,  $R_{REF}$ ,  $C_{REF}$  and  $V_{MEAS}$  values) or capacitive value to represent the load.
4. Record the time to  $V_{MEAS}$ .
5. Compare the results of steps 2 and 4. Add (or subtract) the increase (or decrease) in delay to (or from) the appropriate Output standard adjustment ([Table 26](#)) to yield the worst-case delay of the PCB trace.

## Simultaneously Switching Output Guidelines

This section provides guidelines for the recommended maximum allowable number of Simultaneous Switching Outputs (SSOs). These guidelines describe the maximum number of user I/O pins of a given output signal standard that should simultaneously switch in the same direction, while maintaining a safe level of switching noise. Meeting these guidelines for the stated test conditions ensures that the FPGA operates free from the adverse effects of ground and power bounce.

Ground or power bounce occurs when a large number of outputs simultaneously switch in the same direction. The output drive transistors all conduct current to a common voltage rail. Low-to-High transitions conduct to the  $V_{CCO}$  rail; High-to-Low transitions conduct to the GND rail. The resulting cumulative current transient induces a voltage difference across the inductance that exists between the die pad and the power supply or ground return. The inductance is associated with bonding wires, the package lead frame, and any other signal routing inside the package. Other variables contribute to SSO noise levels, including stray inductance on the PCB as well as capacitive loading at receivers. Any SSO-induced voltage consequently affects internal switching noise margins and ultimately signal quality.

[Table 28](#) and [Table 29](#) provide the essential SSO guidelines. For each device/package combination, [Table 28](#) provides the number of equivalent  $V_{CCO}/GND$  pairs. The equivalent number of pairs is based on characterization and may not match the physical number of pairs. For each output signal standard and drive strength, [Table 29](#) recommends the maximum number of SSOs, switching in the same direction, allowed per  $V_{CCO}/GND$  pair within an I/O bank. The guidelines in [Table 29](#) are categorized by package style, slew rate, and output drive current. Furthermore, the number of SSOs is specified by I/O bank. Generally, the left and right I/O banks (Banks 1 and 3) support higher output drive current.

Multiply the appropriate numbers from [Table 28](#) and [Table 29](#) to calculate the maximum number of SSOs allowed within an I/O bank. Exceeding these SSO guidelines might result in increased power or ground bounce, degraded signal integrity, or increased system jitter.

$$SSO_{MAX}/IO\ Bank = \text{Table 28} \times \text{Table 29}$$

The recommended maximum SSO values assume that the FPGA is soldered on the printed circuit board and that the board uses sound design practices. The SSO values do not apply for FPGAs mounted in sockets, due to the lead inductance introduced by the socket.

The SSO values assume that the  $V_{CCAUX}$  is powered at 3.3V. Setting  $V_{CCAUX}$  to 2.5V provides better SSO characteristics.

The number of SSOs allowed for quad-flat packages (VQ/TQ) is lower than for ball grid array packages (FG) due to the larger lead inductance of the quad-flat packages. Ball grid array packages are recommended for applications with a large number of simultaneously switching outputs.

## Configurable Logic Block (CLB) Timing

Table 30: CLB (SLICEM) Timing

Symbol	Description	Speed Grade				Units	
		-5		-4			
		Min	Max	Min	Max		
<b>Clock-to-Output Times</b>							
T <sub>CKO</sub>	When reading from the FFX (FFY) Flip-Flop, the time from the active transition at the CLK input to data appearing at the XQ (YQ) output	–	0.60	–	0.68	ns	
<b>Setup Times</b>							
T <sub>AS</sub>	Time from the setup of data at the F or G input to the active transition at the CLK input of the CLB	0.18	–	0.36	–	ns	
T <sub>DICK</sub>	Time from the setup of data at the BX or BY input to the active transition at the CLK input of the CLB	1.58	–	1.88	–	ns	
<b>Hold Times</b>							
T <sub>AH</sub>	Time from the active transition at the CLK input to the point where data is last held at the F or G input	0	–	0	–	ns	
T <sub>CKDI</sub>	Time from the active transition at the CLK input to the point where data is last held at the BX or BY input	0	–	0	–	ns	
<b>Clock Timing</b>							
T <sub>CH</sub>	The High pulse width of the CLB's CLK signal	0.63	–	0.75	–	ns	
T <sub>CL</sub>	The Low pulse width of the CLK signal	0.63	–	0.75	–	ns	
F <sub>TOG</sub>	Toggle frequency (for export control)	0	770	0	667	MHz	
<b>Propagation Times</b>							
T <sub>ILO</sub>	The time it takes for data to travel from the CLB's F (G) input to the X (Y) output	–	0.62	–	0.71	ns	
<b>Set/Reset Pulse Width</b>							
T <sub>RPW_CLB</sub>	The minimum allowable pulse width, High or Low, to the CLB's SR input	1.33	–	1.61	–	ns	

### Notes:

1. The numbers in this table are based on the operating conditions set forth in Table 8.

## Configuration Clock (CCLK) Characteristics

Table 46: Master Mode CCLK Output Period by *ConfigRate* Option Setting

Symbol	Description	ConfigRate Setting	Temperature Range	Minimum	Maximum	Units
T <sub>CCLK1</sub>	CCLK clock period by <i>ConfigRate</i> setting	1 (power-on value)	Commercial	1,254	2,500	ns
			Industrial	1,180		ns
T <sub>CCLK3</sub>		3	Commercial	413	833	ns
			Industrial	390		ns
T <sub>CCLK6</sub>		6 (default)	Commercial	207	417	ns
			Industrial	195		ns
T <sub>CCLK7</sub>		7	Commercial	178	357	ns
			Industrial	168		ns
T <sub>CCLK8</sub>		8	Commercial	156	313	ns
			Industrial	147		ns
T <sub>CCLK10</sub>		10	Commercial	123	250	ns
			Industrial	116		ns
T <sub>CCLK12</sub>		12	Commercial	103	208	ns
			Industrial	97		ns
T <sub>CCLK13</sub>		13	Commercial	93	192	ns
			Industrial	88		ns
T <sub>CCLK17</sub>		17	Commercial	72	147	ns
			Industrial	68		ns
T <sub>CCLK22</sub>		22	Commercial	54	114	ns
			Industrial	51		ns
T <sub>CCLK25</sub>		25	Commercial	47	100	ns
			Industrial	45		ns
T <sub>CCLK27</sub>		27	Commercial	44	93	ns
			Industrial	42		ns
T <sub>CCLK33</sub>		33	Commercial	36	76	ns
			Industrial	34		ns
T <sub>CCLK44</sub>		44	Commercial	26	57	ns
			Industrial	25		ns
T <sub>CCLK50</sub>		50	Commercial	22	50	ns
			Industrial	21		ns
T <sub>CCLK100</sub>		100	Commercial	11.2	25	ns
			Industrial	10.6		ns

### Notes:

- Set the **ConfigRate** option value when generating a configuration bitstream.

## VQ100 Footprint (XC3S200A)

Note pin 1 indicator in top-left corner and logo orientation.

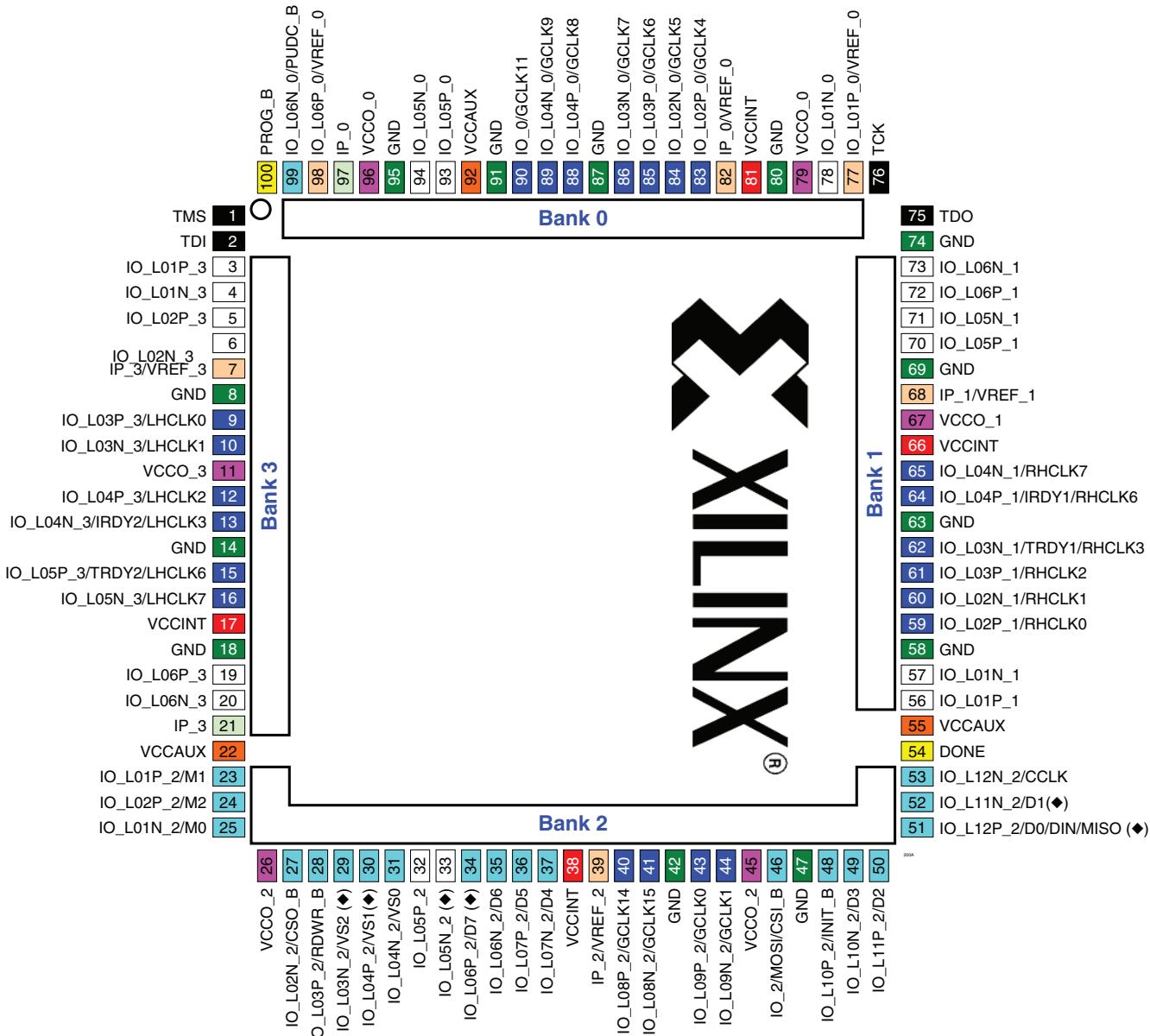


Figure 18: VQ100 Package Footprint - XC3S200A (Top View)

17	I/O: Unrestricted, general-purpose user I/O	20	DUAL: Configuration pins, then possible user I/O	6	VREF: User I/O or input voltage reference for bank
2	INPUT: Unrestricted, general-purpose input pin	23	CLK: User I/O, input, or global buffer input	6	VCCO: Output voltage supply for bank
2	CONFIG: Dedicated configuration pins	4	JTAG: Dedicated JTAG port pins	4	VCCINT: Internal core supply voltage (+1.2V)
0	N.C.: Not connected	13	GND: Ground	3	VCCAUX: Auxiliary supply voltage

## FT256: 256-ball Fine-pitch, Thin Ball Grid Array

The 256-ball fine-pitch, thin ball grid array package, FT256, supports all five Spartan-3A FPGAs. The XC3S200A and XC3S400A have identical footprints, and the XC3S700A and XC3S1400A have identical footprints. The XC3S50A is compatible with the XC3S200A/XC3S400A but has 51 unconnected balls. The XC3S200A/XC3S400A is similar to the XC3S700A/XC3S1400A, but the XC3S700A/XC3S1400A adds more power and ground pins and therefore is not compatible.

**Table 68** lists all the package pins for the XC3S50A, XC3S200A, and XC3S400A. They are sorted by bank number and then by pin name of the largest device. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The highlighted rows indicate pinout differences between the XC3S50A, the XC3S200A, and the XC3S400A FPGAs. The XC3S50A has 51 unconnected balls, indicated as N.C. (No Connection) in **Table 68** and **Figure 20** and with the black diamond character (◆) in **Table 68**. **Figure 21** provides the common footprint for the XC3S200A and XC3S400A.

**Table 68** also indicates that some differential I/O pairs have different assignments between the XC3S50A and the XC3S200A/XC3S400A, highlighted in light blue. See "[Footprint Migration Differences](#)," page 99 for additional information.

All other balls have nearly identical functionality on all three devices. **Table 73** summarizes the XC3S50A FPGA footprint migration differences for the FT256 package.

The XC3S50A does not support the address output pins for the Byte-wide Peripheral Interface (BPI) configuration mode.

**Table 69** lists all the package pins for the XC3S700A and XC3S1400A. They are sorted by bank number and then by pin name. Pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier. **Figure 22** provides the common footprint for the XC3S200A and XC3S400A.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at

[www.xilinx.com/support/documentation/data\\_sheets/s3a\\_pin.zip](http://www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip)

### Pinout Table

**Table 68: Spartan-3A FT256 Pinout (XC3S50A, XC3S200A, XC3S400)**

Bank	XC3S50A	XC3S200A XC3S400A	FT256 Ball	Type
0	IO_L01N_0	IO_L01N_0	C13	I/O
0	IO_L01P_0	IO_L01P_0	D13	I/O
0	IO_L02N_0	IO_L02N_0	B14	I/O
0	IO_L02P_0/ VREF_0	IO_L02P_0/ VREF_0	B15	VREF
0	IO_L03N_0	IO_L03N_0	D11	I/O
0	IO_L03P_0	IO_L03P_0	C12	I/O
0	IO_L04N_0	IO_L04N_0	A13	I/O
0	IO_L04P_0	IO_L04P_0	A14	I/O
0	N.C. (◆)	IO_L05N_0	A12	I/O
0	IP_0	IO_L05P_0	B12	I/O
0	N.C. (◆)	IO_L06N_0/ VREF_0	E10	VREF
0	N.C. (◆)	IO_L06P_0	D10	I/O
0	IO_L07N_0	IO_L07N_0	A11	I/O
0	IO_L07P_0	IO_L07P_0	C11	I/O
0	IO_L08N_0	IO_L08N_0	A10	I/O
0	IO_L08P_0	IO_L08P_0	B10	I/O
0	IO_L09N_0/ GCLK5	IO_L09N_0/ GCLK5	D9	GCLK
0	IO_L09P_0/ GCLK4	IO_L09P_0/ GCLK4	C10	GCLK
0	IO_L10N_0/ GCLK7	IO_L10N_0/ GCLK7	A9	GCLK
0	IO_L10P_0/ GCLK6	IO_L10P_0/ GCLK6	C9	GCLK
0	IO_L11N_0/ GCLK9	IO_L11N_0/ GCLK9	D8	GCLK
0	IO_L11P_0/ GCLK8	IO_L11P_0/ GCLK8	C8	GCLK
0	IO_L12N_0/ GCLK11	IO_L12N_0/ GCLK11	B8	GCLK
0	IO_L12P_0/ GCLK10	IO_L12P_0/ GCLK10	A8	GCLK
0	N.C. (◆)	IO_L13N_0	C7	I/O
0	N.C. (◆)	IO_L13P_0	A7	I/O
0	N.C. (◆)	IO_L14N_0/ VREF_0	E7	VREF
0	N.C. (◆)	IO_L14P_0	F8	I/O
0	IO_L15N_0	IO_L15N_0	B6	I/O
0	IO_L15P_0	IO_L15P_0	A6	I/O
0	IO_L16N_0	IO_L16N_0	C6	I/O
0	IO_L16P_0	IO_L16P_0	D7	I/O
0	IO_L17N_0	IO_L17N_0	C5	I/O

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
3	IO_L16N_3	L2	I/O
3	IO_L16P_3/VREF_3	L1	VREF
3	IO_L18N_3	L3	I/O
3	IO_L18P_3	K4	I/O
3	IO_L19N_3	L4	I/O
3	IO_L19P_3	M3	I/O
3	IO_L20N_3	N1	I/O
3	IO_L20P_3	M1	I/O
3	IO_L22N_3	P1	I/O
3	IO_L22P_3/VREF_3	N2	VREF
3	IO_L23N_3	P2	I/O
3	IO_L23P_3	R1	I/O
3	IO_L24N_3	M4	I/O
3	IO_L24P_3	N3	I/O
3	IP_3	J4	INPUT
3	IP_3/VREF_3	G4	VREF
3	IP_3/VREF_3	J5	VREF
3	VCCO_3	D2	VCCO
3	VCCO_3	H2	VCCO
3	VCCO_3	M2	VCCO
GND	GND	A1	GND
GND	GND	A16	GND
GND	GND	B11	GND
GND	GND	B7	GND
GND	GND	C14	GND
GND	GND	C3	GND
GND	GND	E10	GND
GND	GND	E12	GND
GND	GND	E5	GND
GND	GND	F11	GND
GND	GND	F2	GND
GND	GND	F6	GND
GND	GND	F7	GND
GND	GND	F8	GND
GND	GND	F9	GND
GND	GND	G10	GND
GND	GND	G12	GND
GND	GND	G15	GND
GND	GND	G5	GND
GND	GND	G6	GND

Table 69: Spartan-3A FT256 Pinout (XC3S700A,

Bank	XC3S700A XC3S1400A	FT256 Ball	Type
GND	GND	G8	GND
GND	GND	H11	GND
GND	GND	H5	GND
GND	GND	H7	GND
GND	GND	H9	GND
GND	GND	J10	GND
GND	GND	J6	GND
GND	GND	J8	GND
GND	GND	K11	GND
GND	GND	K12	GND
GND	GND	K2	GND
GND	GND	K5	GND
GND	GND	K7	GND
GND	GND	K9	GND
GND	GND	L10	GND
GND	GND	L11	GND
GND	GND	L15	GND
GND	GND	L6	GND
GND	GND	L8	GND
GND	GND	M12	GND
GND	GND	M5	GND
GND	GND	M8	GND
GND	GND	N10	GND
GND	GND	N7	GND
GND	GND	P14	GND
GND	GND	P3	GND
GND	GND	R10	GND
GND	GND	R6	GND
GND	GND	T1	GND
GND	GND	T16	GND
VCCAUX	SUSPEND	R16	PWRMGT
VCCAUX	DONE	T15	CONFIG
VCCAUX	PROG_B	A2	CONFIG
VCCAUX	TCK	A15	JTAG
VCCAUX	TDI	B1	JTAG
VCCAUX	TDO	B16	JTAG
VCCAUX	TMS	B2	JTAG
VCCAUX	VCCAUX	D6	VCCAUX
VCCAUX	VCCAUX	E11	VCCAUX
VCCAUX	VCCAUX	F12	VCCAUX

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
0	IP_0	F12	INPUT
0	IP_0	G7	INPUT
0	IP_0	G8	INPUT
0	IP_0	G9	INPUT
0	IP_0	G11	INPUT
0	IP_0/VREF_0	E10	VREF
0	VCCO_0	B5	VCCO
0	VCCO_0	B14	VCCO
0	VCCO_0	D11	VCCO
0	VCCO_0	E8	VCCO
1	IO_L01N_1/LDC2	T17	DUAL
1	IO_L01P_1/HDC	R16	DUAL
1	IO_L02N_1/LDC0	U18	DUAL
1	IO_L02P_1/LDC1	U17	DUAL
1	IO_L03N_1/A1	R17	DUAL
1	IO_L03P_1/A0	T18	DUAL
1	IO_L05N_1	N16	I/O
1	IO_L05P_1	P16	I/O
1	IO_L06N_1	M14	I/O
1	IO_L06P_1	N15	I/O
1	IO_L07N_1/VREF_1	P18	VREF
1	IO_L07P_1	R18	I/O
1	IO_L09N_1/A3	M17	DUAL
1	IO_L09P_1/A2	M16	DUAL
1	IO_L10N_1/A5	N18	DUAL
1	IO_L10P_1/A4	N17	DUAL
1	IO_L11N_1/A7	L12	DUAL
1	IO_L11P_1/A6	L13	DUAL
1	IO_L13N_1/A9	K16	DUAL
1	IO_L13P_1/A8	L17	DUAL
1	IO_L14N_1/RHCLK1	K17	RHCLK
1	IO_L14P_1/RHCLK0	L18	RHCLK
1	IO_L15N_1/TRDY1/RHCLK3	J17	RHCLK
1	IO_L15P_1/RHCLK2	K18	RHCLK
1	IO_L17N_1/RHCLK5	K15	RHCLK
1	IO_L17P_1/RHCLK4	J16	RHCLK
1	IO_L18N_1/RHCLK7	H17	RHCLK
1	IO_L18P_1/IRDY1/RHCLK6	H18	RHCLK
1	IO_L19N_1/A11	G16	DUAL
1	IO_L19P_1/A10	H16	DUAL

Table 77: Spartan-3A FG320 Pinout(Continued)

Bank	Pin Name	FG320 Ball	Type
1	IO_L21N_1	F17	I/O
1	IO_L21P_1	G17	I/O
1	IO_L22N_1/A13	E18	DUAL
1	IO_L22P_1/A12	F18	DUAL
1	IO_L23N_1/A15	H15	DUAL
1	IO_L23P_1/A14	J14	DUAL
1	IO_L25N_1	D17	I/O
1	IO_L25P_1	D18	I/O
1	IO_L26N_1/A17	E16	DUAL
1	IO_L26P_1/A16	F16	DUAL
1	IO_L27N_1/A19	F15	DUAL
1	IO_L27P_1/A18	G15	DUAL
1	IO_L29N_1/A21	E15	DUAL
1	IO_L29P_1/A20	D16	DUAL
1	IO_L30N_1/A23	B18	DUAL
1	IO_L30P_1/A22	C18	DUAL
1	IO_L31N_1/A25	B17	DUAL
1	IO_L31P_1/A24	C17	DUAL
1	IP_L04N_1/VREF_1	N14	VREF
1	IP_L04P_1	P15	INPUT
1	IP_L08N_1/VREF_1	L14	VREF
1	IP_L08P_1	M13	INPUT
1	IP_L12N_1	L16	INPUT
1	IP_L12P_1/VREF_1	M15	VREF
1	IP_L16N_1	K14	INPUT
1	IP_L16P_1	K13	INPUT
1	IP_L20N_1	J13	INPUT
1	IP_L20P_1/VREF_1	K12	VREF
1	IP_L24N_1	G14	INPUT
1	IP_L24P_1	H13	INPUT
1	IP_L28N_1	G13	INPUT
1	IP_L28P_1/VREF_1	H12	VREF
1	IP_L32N_1	F13	INPUT
1	IP_L32P_1/VREF_1	F14	VREF
1	VCCO_1	E17	VCCO
1	VCCO_1	H14	VCCO
1	VCCO_1	L15	VCCO
1	VCCO_1	P17	VCCO
2	IO_L01N_2/M0	U3	DUAL
2	IO_L01P_2/M1	T3	DUAL

Table 81: Spartan-3A FG400 Pinout(*Continued*)

Bank	Pin Name	FG400 Ball	Type
VCCAUX	TDO	E17	JTAG
VCCAUX	TMS	E4	JTAG
VCCAUX	VCCAUX	A13	VCCAUX
VCCAUX	VCCAUX	E16	VCCAUX
VCCAUX	VCCAUX	H1	VCCAUX
VCCAUX	VCCAUX	K13	VCCAUX
VCCAUX	VCCAUX	L8	VCCAUX
VCCAUX	VCCAUX	N20	VCCAUX
VCCAUX	VCCAUX	T5	VCCAUX
VCCAUX	VCCAUX	Y8	VCCAUX
VCCINT	VCCINT	J10	VCCINT
VCCINT	VCCINT	J12	VCCINT
VCCINT	VCCINT	K9	VCCINT
VCCINT	VCCINT	K11	VCCINT
VCCINT	VCCINT	L10	VCCINT
VCCINT	VCCINT	L12	VCCINT
VCCINT	VCCINT	M9	VCCINT
VCCINT	VCCINT	M11	VCCINT
VCCINT	VCCINT	N10	VCCINT

## User I/Os by Bank

Table 82 indicates how the 311 available user-I/O pins are distributed between the four I/O banks on the FG400 package. The AWAKE pin is counted as a dual-purpose I/O.

Table 82: User I/Os Per Bank for the XC3S400A and XC3S700A in the FG400 Package

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	77	50	12	1	6	8
Right	1	79	21	12	30	8	8
Bottom	2	76	35	6	21	6	8
Left	3	79	49	16	0	6	8
<b>TOTAL</b>		<b>311</b>	<b>155</b>	<b>46</b>	<b>52</b>	<b>26</b>	<b>32</b>

## Footprint Migration Differences

The XC3S400A and XC3S700A FPGAs have identical footprints in the FG400 package. Designs can migrate between the XC3S400A and XC3S700A FPGAs without further consideration.

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
2	VCCO_2	AA18	VCCO
2	VCCO_2	AA5	VCCO
2	VCCO_2	AA9	VCCO
2	VCCO_2	U14	VCCO
2	VCCO_2	U9	VCCO
3	IO_L01N_3	D2	I/O
3	IO_L01P_3	C1	I/O
3	IO_L02N_3	C2	I/O
3	IO_L02P_3	B1	I/O
3	IO_L03N_3	E4	I/O
3	IO_L03P_3	D3	I/O
3	IO_L05N_3	G5	I/O
3	IO_L05P_3	G6	I/O
3	IO_L06N_3	E1	I/O
3	IO_L06P_3	D1	I/O
3	IO_L07N_3	E3	I/O
3	IO_L07P_3	F4	I/O
3	IO_L08N_3	G4	I/O
3	IO_L08P_3	F3	I/O
3	IO_L09N_3	H6	I/O
3	IO_L09P_3	H5	I/O
3	IO_L10N_3	J5	I/O
3	IO_L10P_3	K6	I/O
3	IO_L12N_3	F1	I/O
3	IO_L12P_3	F2	I/O
3	IO_L13N_3	G1	I/O
3	IO_L13P_3	G3	I/O
3	IO_L14N_3	H3	I/O
3	IO_L14P_3	H4	I/O
3	IO_L16N_3	H1	I/O
3	IO_L16P_3	H2	I/O
3	IO_L17N_3/VREF_3	J1	VREF
3	IO_L17P_3	J3	I/O
3	IO_L18N_3	K4	I/O
3	IO_L18P_3	K5	I/O
3	IO_L20N_3	K2	I/O
3	IO_L20P_3	K3	I/O
3	IO_L21N_3/LHCLK1	L3	LHCLK
3	IO_L21P_3/LHCLK0	L5	LHCLK
3	IO_L22N_3/IRDY2/LHCLK3	L1	LHCLK

Table 83: Spartan-3A FG484 Pinout(Continued)

Bank	Pin Name	FG484 Ball	Type
3	IO_L22P_3/LHCLK2	K1	LHCLK
3	IO_L24N_3/LHCLK5	M2	LHCLK
3	IO_L24P_3/LHCLK4	M1	LHCLK
3	IO_L25N_3/LHCLK7	M4	LHCLK
3	IO_L25P_3/IRDY2/LHCLK6	M3	LHCLK
3	IO_L26N_3	N3	I/O
3	IO_L26P_3/VREF_3	N1	VREF
3	IO_L28N_3	P2	I/O
3	IO_L28P_3	P1	I/O
3	IO_L29N_3	P5	I/O
3	IO_L29P_3	P3	I/O
3	IO_L30N_3	N4	I/O
3	IO_L30P_3	M5	I/O
3	IO_L32N_3	R2	I/O
3	IO_L32P_3	R1	I/O
3	IO_L33N_3	R4	I/O
3	IO_L33P_3	R3	I/O
3	IO_L34N_3	T4	I/O
3	IO_L34P_3	R5	I/O
3	IO_L36N_3	T3	I/O
3	IO_L36P_3/VREF_3	T1	VREF
3	IO_L37N_3	U2	I/O
3	IO_L37P_3	U1	I/O
3	IO_L38N_3	V3	I/O
3	IO_L38P_3	V1	I/O
3	IO_L40N_3	U5	I/O
3	IO_L40P_3	T5	I/O
3	IO_L41N_3	U4	I/O
3	IO_L41P_3	U3	I/O
3	IO_L42N_3	W2	I/O
3	IO_L42P_3	W1	I/O
3	IO_L43N_3	W3	I/O
3	IO_L43P_3	V4	I/O
3	IO_L44N_3	Y2	I/O
3	IO_L44P_3	Y1	I/O
3	IO_L45N_3	AA2	I/O
3	IO_L45P_3	AA1	I/O
3	IP_3/VREF_3	J8	VREF
3	IP_3/VREF_3	R6	VREF
3	IP_L04N_3/VREF_3	H7	VREF

Table 83: Spartan-3A FG484 Pinout(*Continued*)

Bank	Pin Name	FG484 Ball	Type
VCCAUX	DONE	Y19	CONFIG
VCCAUX	PROG_B	C4	CONFIG
VCCAUX	TCK	A21	JTAG
VCCAUX	TDI	F5	JTAG
VCCAUX	TDO	E19	JTAG
VCCAUX	TMS	D4	JTAG
VCCAUX	VCCAUX	D12	VCCAUX
VCCAUX	VCCAUX	E18	VCCAUX
VCCAUX	VCCAUX	E5	VCCAUX
VCCAUX	VCCAUX	H11	VCCAUX
VCCAUX	VCCAUX	L4	VCCAUX
VCCAUX	VCCAUX	M19	VCCAUX
VCCAUX	VCCAUX	P11	VCCAUX
VCCAUX	VCCAUX	V18	VCCAUX
VCCAUX	VCCAUX	V5	VCCAUX
VCCAUX	VCCAUX	W11	VCCAUX
VCCINT	VCCINT	J10	VCCINT
VCCINT	VCCINT	J12	VCCINT
VCCINT	VCCINT	K11	VCCINT
VCCINT	VCCINT	K13	VCCINT
VCCINT	VCCINT	K9	VCCINT
VCCINT	VCCINT	L10	VCCINT
VCCINT	VCCINT	L12	VCCINT
VCCINT	VCCINT	L14	VCCINT
VCCINT	VCCINT	M11	VCCINT
VCCINT	VCCINT	M13	VCCINT
VCCINT	VCCINT	M9	VCCINT
VCCINT	VCCINT	N10	VCCINT
VCCINT	VCCINT	N12	VCCINT
VCCINT	VCCINT	N14	VCCINT
VCCINT	VCCINT	P13	VCCINT

## User I/Os by Bank

**Table 84** and **Table 85** indicate how the user-I/O pins are distributed between the four I/O banks on the FG484 package. The AWAKE pin is counted as a dual-purpose I/O.

**Table 84: User I/Os Per Bank for the XC3S700A in the FG484 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	92	58	17	1	8	8
Right	1	94	33	15	30	8	8
Bottom	2	92	43	11	21	9	8
Left	3	94	61	17	0	8	8
<b>TOTAL</b>		<b>372</b>	<b>195</b>	<b>60</b>	<b>52</b>	<b>33</b>	<b>32</b>

**Table 85: User I/Os Per Bank for the XC3S1400A in the FG484 Package**

Package Edge	I/O Bank	Maximum I/O	All Possible I/O Pins by Type				
			I/O	INPUT	DUAL	VREF	CLK
Top	0	92	58	17	1	8	8
Right	1	94	33	15	30	8	8
Bottom	2	95	43	13	21	10	8
Left	3	94	61	17	0	8	8
<b>TOTAL</b>		<b>375</b>	<b>195</b>	<b>62</b>	<b>52</b>	<b>34</b>	<b>32</b>

## Footprint Migration Differences

**Table 86** summarizes any footprint and functionality differences between the XC3S700A and the XC3S1400A FPGAs that might affect easy migration between devices available in the FG484 package. There are three such balls. All other pins not listed in **Table 86** unconditionally migrate between Spartan-3A devices available in the FG484 package.

The arrows indicate the direction for easy migration.

**Table 86: FG484 Footprint Migration Differences**

Pin	Bank	XC3S700A	Migration	XC3S1400A
T8	2	N.C.	→	INPUT/VREF
U7	2	N.C.	→	INPUT
U16	2	N.C.	→	INPUT
<b>DIFFERENCES</b>		<b>3</b>		

Legend:

- This pin can unconditionally migrate from the device on the left to the device on the right. Migration in the other direction is possible depending on how the pin is configured for the device on the right.

## FG484 Footprint

### Left Half of FG484 Package (Top View)

195 I/O: Unrestricted, general-purpose user I/O

60-62 INPUT: Unrestricted, general-purpose input pin

51 DUAL: Configuration pins, then possible user I/O

33-34 VREF: User I/O or input voltage reference for bank

32 CLK: User I/O, input, or clock buffer input

2 SUSPEND: Dedicated SUSPEND and dual-purpose AWAKE Power Management pins

2 CONFIG: Dedicated configuration pins

4 JTAG: Dedicated JTAG port pins

53 GND: Ground

24 VCCO: Output voltage supply for bank

15 VCCINT: Internal core supply voltage (+1.2V)

10 VCCAUX: Auxiliary supply voltage

3 N.C.: Not connected (XC3S700A only)

Bank 0											
A	GND	I/O L36N_0 PUDC_B	I/O L33P_0	I/O L31P_0	I/O L28N_0	I/O L26N_0	I/O L26P_0	I/O L22N_0	I/O L22P_0	I/O L21P_0	I/O L18N_0 GCLK7
B	I/O L02P_3	I/O L36P_0 VREF_0	I/O L33N_0	I/O L31N_0	VCCO_0	I/O L28P_0	GND	I/O L25P_0	I/O L24P_0	VCCO_0	I/O L19P_0 GCLK8
C	I/O L01P_3	I/O L02N_3	GND	PROG_B		I/O L32P_0	I/O L29P_0	I/O L27N_0	I/O L25N_0	I/O L24N_0 VREF_0	I/O L21N_0
D	I/O L06P_3	I/O L01N_3	I/O L03P_3	TMS		I/O L32N_0	I/O L29N_0	I/O L27P_0	I/O L30N_0	GND	I/O L23P_0
E	I/O L06N_3	VCCO_3	I/O L07N_3	I/O L03N_3	VCCAUX	I/O L35N_0	I/O L34P_0	INPUT	I/O L30P_0	I/O L23N_0	I/O L20N_0 GCLK11
F	I/O L12N_3	I/O L12P_3	I/O L08P_3	I/O L07P_3	TDI	GND	I/O L35P_0	I/O L34N_0	VCCO_0	INPUT	GND
G	I/O L13N_3	GND	I/O L13P_3	I/O L08N_3	I/O L05N_3	I/O L05P_3	INPUT	INPUT VREF_0	INPUT	INPUT	INPUT
H	I/O L16N_3	I/O L16P_3	I/O L14N_3	I/O L14P_3	I/O L09P_3	I/O L09N_3	INPUT L04N_3 VREF_3	INPUT L04P_3	INPUT VREF_0	INPUT	VCCAUX
J	I/O L17N_3 VREF_3	VCCO_3	I/O L17P_3	GND	I/O L10N_3	VCCO_3	INPUT L11P_3	INPUT L11N_3 VREF_3	GND	VCCINT	GND
K	I/O L22P_3 LHCLK2	I/O L20N_3	I/O L20P_3	I/O L18N_3	I/O L18P_3	I/O L10P_3	INPUT L11P_3	INPUT L11N_3	VCCINT	GND	VCCINT
L	I/O L22N_3 IRDY2 LHCLK3	GND	I/O L21N_3 LHCLK1	VCCAUX	I/O L21P_3 LHCLK0	GND	INPUT L19P_3	INPUT L19N_3 VREF_3	GND	VCCINT	GND
M	I/O L24P_3 LHCLK4	I/O L24N_3 LHCLK5	I/O L25P_3 LHCLK6	I/O L25N_3 LHCLK7	I/O L30P_3	INPUT L23N_3	INPUT L23P_3	INPUT L19N_3	VCCINT	GND	VCCINT
N	I/O L26P_3 VREF_3	VCCO_3	I/O L26N_3	I/O L30N_3	INPUT L31N_3	INPUT L31P_3	INPUT L35P_3	INPUT L27P_3	INPUT L27N_3	VCCINT	GND
P	I/O L28P_3	I/O L28N_3	I/O L29P_3	GND	I/O L29N_3	VCCO_3	INPUT L39P_3	INPUT L35N_3	GND	GND	VCCAUX
R	I/O L32P_3	I/O L32N_3	I/O L33P_3	I/O L33N_3	I/O L34P_3	INPUT VREF_3	INPUT L46P_3	INPUT L39N_3	INPUT	INPUT	INPUT
T	I/O L36P_3 VREF_3	GND	I/O L36N_3	I/O L34N_3	I/O L40P_3	INPUT L46N_3 VREF_3	INPUT VREF_2	INPUT VREF_2	INPUT VREF_2	INPUT VREF_2	INPUT VREF_2
U	I/O L37P_3	I/O L37N_3	I/O L41P_3	I/O L41N_3	I/O L40N_3	GND	INPUT	INPUT	VCCO_2	INPUT	I/O L17P_2 GCLK12
V	I/O L38P_3	VCCO_3	I/O L38N_3	I/O L43P_3	VCCAUX	I/O L01P_2 M1	INPUT	INPUT VREF_2	I/O L09P_2 RDWR_B	I/O L13P_2	I/O L17N_2 GCLK13
W	I/O L42P_3	I/O L42N_3	I/O L43N_3	I/O L02P_2 M2	I/O L01N_2 M0	I/O L05P_2	I/O L07P_2	I/O L11P_2 VS1	I/O L09N_2 VS2	GND	VCCAUX
Y	I/O L44P_3	I/O L44N_3	GND	I/O L02N_2 CSO_B	I/O L05N_2	I/O L07N_2	I/O L10P_2	I/O L11N_2 VS0	I/O L14P_2 D7	I/O L13N_2	I/O L16P_2 D5
A	I/O L45P_3	I/O L45N_3	I/O L03N_2	I/O L04N_2	VCCO_2	I/O L08P_2	GND	I/O L12P_2	VCCO_2	I/O L15P_2	GND
A	GND	I/O L03P_2	I/O L04P_2	I/O L06P_2	I/O L06N_2	I/O L08N_2	I/O L10N_2	I/O L12N_2	I/O L14N_2 D6	I/O L15N_2	I/O L16N_2 D4
B											

Figure 25: FG484 Package Footprint (Top View)

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## FG676: 676-ball Fine-pitch Ball Grid Array

The 676-ball fine-pitch ball grid array, FG676, supports the XC3S1400A FPGA.

**Table 87** lists all the FG676 package pins. They are sorted by bank number and then by pin name. Pairs of pins that form a differential I/O pair appear together in the table. The table also shows the pin number for each pin and the pin type, as defined earlier.

The XC3S1400A has 17 unconnected balls, indicated as N.C. (No Connection) in **Table 87** and with the black diamond character (◆) in **Table 87** and **Figure 27**.

An electronic version of this package pinout table and footprint diagram is available for download from the Xilinx website at:

[www.xilinx.com/support/documentation/data\\_sheets/s3a\\_pin.zip](http://www.xilinx.com/support/documentation/data_sheets/s3a_pin.zip).

### Pinout Table

**Table 87: Spartan-3A FG676 Pinout**

Bank	Pin Name	FG676 Ball	Type
0	IO_L01N_0	F20	I/O
0	IO_L01P_0	G20	I/O
0	IO_L02N_0	F19	I/O
0	IO_L02P_0/VREF_0	G19	VREF
0	IO_L05N_0	C22	I/O
0	IO_L05P_0	D22	I/O
0	IO_L06N_0	C23	I/O
0	IO_L06P_0	D23	I/O
0	IO_L07N_0	A22	I/O
0	IO_L07P_0	B23	I/O
0	IO_L08N_0	G17	I/O
0	IO_L08P_0	H17	I/O
0	IO_L09N_0	B21	I/O
0	IO_L09P_0	C21	I/O
0	IO_L10N_0	D21	I/O
0	IO_L10P_0	E21	I/O
0	IO_L11N_0	C20	I/O
0	IO_L11P_0	D20	I/O
0	IO_L12N_0	K16	I/O
0	IO_L12P_0	J16	I/O
0	IO_L13N_0	E17	I/O
0	IO_L13P_0	F17	I/O
0	IO_L14N_0	A20	I/O
0	IO_L14P_0/VREF_0	B20	VREF

**Table 87: Spartan-3A FG676 Pinout(Continued)**

Bank	Pin Name	FG676 Ball	Type
0	IO_L15N_0	A19	I/O
0	IO_L15P_0	B19	I/O
0	IO_L16N_0	H15	I/O
0	IO_L16P_0	G15	I/O
0	IO_L17N_0	C18	I/O
0	IO_L17P_0	D18	I/O
0	IO_L18N_0	A18	I/O
0	IO_L18P_0	B18	I/O
0	IO_L19N_0	B17	I/O
0	IO_L19P_0	C17	I/O
0	IO_L20N_0/VREF_0	E15	VREF
0	IO_L20P_0	F15	I/O
0	IO_L21N_0	C16	I/O
0	IO_L21P_0	D17	I/O
0	IO_L22N_0	C15	I/O
0	IO_L22P_0	D16	I/O
0	IO_L23N_0	A15	I/O
0	IO_L23P_0	B15	I/O
0	IO_L24N_0	F14	I/O
0	IO_L24P_0	E14	I/O
0	IO_L25N_0/GCLK5	J14	GCLK
0	IO_L25P_0/GCLK4	K14	GCLK
0	IO_L26N_0/GCLK7	A14	GCLK
0	IO_L26P_0/GCLK6	B14	GCLK
0	IO_L27N_0/GCLK9	G13	GCLK
0	IO_L27P_0/GCLK8	F13	GCLK
0	IO_L28N_0/GCLK11	C13	GCLK
0	IO_L28P_0/GCLK10	B13	GCLK
0	IO_L29N_0	B12	I/O
0	IO_L29P_0	A12	I/O
0	IO_L30N_0	C12	I/O
0	IO_L30P_0	D13	I/O
0	IO_L31N_0	F12	I/O
0	IO_L31P_0	E12	I/O
0	IO_L32N_0/VREF_0	D11	VREF
0	IO_L32P_0	C11	I/O
0	IO_L33N_0	B10	I/O
0	IO_L33P_0	A10	I/O

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
0	IO_L34N_0	D10	I/O
0	IO_L34P_0	C10	I/O
0	IO_L35N_0	H12	I/O
0	IO_L35P_0	G12	I/O
0	IO_L36N_0	B9	I/O
0	IO_L36P_0	A9	I/O
0	IO_L37N_0	D9	I/O
0	IO_L37P_0	E10	I/O
0	IO_L38N_0	B8	I/O
0	IO_L38P_0	A8	I/O
0	IO_L39N_0	K12	I/O
0	IO_L39P_0	J12	I/O
0	IO_L40N_0	D8	I/O
0	IO_L40P_0	C8	I/O
0	IO_L41N_0	C6	I/O
0	IO_L41P_0	B6	I/O
0	IO_L42N_0	C7	I/O
0	IO_L42P_0	B7	I/O
0	IO_L43N_0	K11	I/O
0	IO_L43P_0	J11	I/O
0	IO_L44N_0	D6	I/O
0	IO_L44P_0	C5	I/O
0	IO_L45N_0	B4	I/O
0	IO_L45P_0	A4	I/O
0	IO_L46N_0	H10	I/O
0	IO_L46P_0	G10	I/O
0	IO_L47N_0	H9	I/O
0	IO_L47P_0	G9	I/O
0	IO_L48N_0	E7	I/O
0	IO_L48P_0	F7	I/O
0	IO_L51N_0	B3	I/O
0	IO_L51P_0	A3	I/O
0	IO_L52N_0/PUDC_B	G8	DUAL
0	IO_L52P_0/VREF_0	F8	VREF
0	IP_0	A5	INPUT
0	IP_0	A7	INPUT
0	IP_0	A13	INPUT
0	IP_0	A17	INPUT
0	IP_0	A23	INPUT
0	IP_0	C4	INPUT

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
0	IP_0	D12	INPUT
0	IP_0	D15	INPUT
0	IP_0	D19	INPUT
0	IP_0	E11	INPUT
0	IP_0	E18	INPUT
0	IP_0	E20	INPUT
0	IP_0	F10	INPUT
0	IP_0	G14	INPUT
0	IP_0	G16	INPUT
0	IP_0	H13	INPUT
0	IP_0	H18	INPUT
0	IP_0	J10	INPUT
0	IP_0	J13	INPUT
0	IP_0	J15	INPUT
0	IP_0/VREF_0	D7	VREF
0	IP_0/VREF_0	D14	VREF
0	IP_0/VREF_0	G11	VREF
0	IP_0/VREF_0	J17	VREF
0	N.C. (♦)	A24	N.C.
0	N.C. (♦)	B24	N.C.
0	N.C. (♦)	D5	N.C.
0	N.C. (♦)	E9	N.C.
0	N.C. (♦)	F18	N.C.
0	N.C. (♦)	E6	N.C.
0	N.C. (♦)	F9	N.C.
0	N.C. (♦)	G18	N.C.
0	VCCO_0	B5	VCCO
0	VCCO_0	B11	VCCO
0	VCCO_0	B16	VCCO
0	VCCO_0	B22	VCCO
0	VCCO_0	E8	VCCO
0	VCCO_0	E13	VCCO
0	VCCO_0	E19	VCCO
0	VCCO_0	H11	VCCO
0	VCCO_0	H16	VCCO
1	IO_L01N_1/LDC2	Y21	DUAL
1	IO_L01P_1/HDC	Y20	DUAL
1	IO_L02N_1/LDC0	AD25	DUAL
1	IO_L02P_1/LDC1	AE26	DUAL
1	IO_L03N_1/A1	AC24	DUAL

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
2	IO_L16N_2	W12	I/O
2	IO_L16P_2	V12	I/O
2	IO_L17N_2/VS2	AA12	DUAL
2	IO_L17P_2/RDWR_B	Y12	DUAL
2	IO_L18N_2	AF8	I/O
2	IO_L18P_2	AE8	I/O
2	IO_L19N_2/VS0	AF9	DUAL
2	IO_L19P_2/VS1	AE9	DUAL
2	IO_L20N_2	W13	I/O
2	IO_L20P_2	V13	I/O
2	IO_L21N_2	AC12	I/O
2	IO_L21P_2	AB12	I/O
2	IO_L22N_2/D6	AF10	DUAL
2	IO_L22P_2/D7	AE10	DUAL
2	IO_L23N_2	AC11	I/O
2	IO_L23P_2	AD11	I/O
2	IO_L24N_2/D4	AE12	DUAL
2	IO_L24P_2/D5	AF12	DUAL
2	IO_L25N_2/GCLK13	Y13	GCLK
2	IO_L25P_2/GCLK12	AA13	GCLK
2	IO_L26N_2/GCLK15	AE13	GCLK
2	IO_L26P_2/GCLK14	AF13	GCLK
2	IO_L27N_2/GCLK1	AA14	GCLK
2	IO_L27P_2/GCLK0	Y14	GCLK
2	IO_L28N_2/GCLK3	AE14	GCLK
2	IO_L28P_2/GCLK2	AF14	GCLK
2	IO_L29N_2	AC14	I/O
2	IO_L29P_2	AD14	I/O
2	IO_L30N_2/MOSI/CSI_B	AB15	DUAL
2	IO_L30P_2	AC15	I/O
2	IO_L31N_2	W15	I/O
2	IO_L31P_2	V14	I/O
2	IO_L32N_2/DOUT	AE15	DUAL
2	IO_L32P_2/AWAKE	AD15	PWR MGMT
2	IO_L33N_2	AD17	I/O
2	IO_L33P_2	AE17	I/O
2	IO_L34N_2/D3	Y15	DUAL
2	IO_L34P_2/INIT_B	AA15	DUAL
2	IO_L35N_2	U15	I/O

Table 87: Spartan-3A FG676 Pinout(Continued)

Bank	Pin Name	FG676 Ball	Type
2	IO_L35P_2	V15	I/O
2	IO_L36N_2/D1	AE18	DUAL
2	IO_L36P_2/D2	AF18	DUAL
2	IO_L37N_2	AE19	I/O
2	IO_L37P_2	AF19	I/O
2	IO_L38N_2	AB16	I/O
2	IO_L38P_2	AC16	I/O
2	IO_L39N_2	AE20	I/O
2	IO_L39P_2	AF20	I/O
2	IO_L40N_2	AC19	I/O
2	IO_L40P_2	AD19	I/O
2	IO_L41N_2	AC20	I/O
2	IO_L41P_2	AD20	I/O
2	IO_L42N_2	U16	I/O
2	IO_L42P_2	V16	I/O
2	IO_L43N_2	Y17	I/O
2	IO_L43P_2	AA17	I/O
2	IO_L44N_2	AD21	I/O
2	IO_L44P_2	AE21	I/O
2	IO_L45N_2	AC21	I/O
2	IO_L45P_2	AD22	I/O
2	IO_L46N_2	V17	I/O
2	IO_L46P_2	W17	I/O
2	IO_L47N_2	AA18	I/O
2	IO_L47P_2	AB18	I/O
2	IO_L48N_2	AE23	I/O
2	IO_L48P_2	AF23	I/O
2	IO_L51N_2	AE25	I/O
2	IO_L51P_2	AF25	I/O
2	IO_L52N_2/CCLK	AE24	DUAL
2	IO_L52P_2/D0/DIN/MISO	AF24	DUAL
2	IP_2	AA19	INPUT
2	IP_2	AB13	INPUT
2	IP_2	AB17	INPUT
2	IP_2	AB20	INPUT
2	IP_2	AC7	INPUT
2	IP_2	AC13	INPUT
2	IP_2	AC17	INPUT
2	IP_2	AC18	INPUT
2	IP_2	AD9	INPUT

Table 87: Spartan-3A FG676 Pinout(*Continued*)

Bank	Pin Name	FG676 Ball	Type
3	IP_L58P_3	AA4	INPUT
3	IP_L62N_3	AB4	INPUT
3	IP_L62P_3	AB3	INPUT
3	IP_L66N_3/VREF_3	AE2	VREF
3	IP_L66P_3	AE1	INPUT
3	VCCO_3	AB2	VCCO
3	VCCO_3	E2	VCCO
3	VCCO_3	H5	VCCO
3	VCCO_3	L2	VCCO
3	VCCO_3	L8	VCCO
3	VCCO_3	P5	VCCO
3	VCCO_3	T2	VCCO
3	VCCO_3	T8	VCCO
3	VCCO_3	W5	VCCO
GND	GND	A1	GND
GND	GND	A6	GND
GND	GND	A11	GND
GND	GND	A16	GND
GND	GND	A21	GND
GND	GND	A26	GND
GND	GND	AA1	GND
GND	GND	AA6	GND
GND	GND	AA11	GND
GND	GND	AA16	GND
GND	GND	AA21	GND
GND	GND	AA26	GND
GND	GND	AD3	GND
GND	GND	AD8	GND
GND	GND	AD13	GND
GND	GND	AD18	GND
GND	GND	AD24	GND
GND	GND	AF1	GND
GND	GND	AF6	GND
GND	GND	AF11	GND
GND	GND	AF16	GND
GND	GND	AF21	GND
GND	GND	AF26	GND
GND	GND	C3	GND
GND	GND	C9	GND
GND	GND	C14	GND

Table 87: Spartan-3A FG676 Pinout(*Continued*)

Bank	Pin Name	FG676 Ball	Type
GND	GND	C19	GND
GND	GND	C24	GND
GND	GND	F1	GND
GND	GND	F6	GND
GND	GND	F11	GND
GND	GND	F16	GND
GND	GND	F21	GND
GND	GND	F26	GND
GND	GND	H3	GND
GND	GND	H8	GND
GND	GND	H14	GND
GND	GND	H19	GND
GND	GND	J24	GND
GND	GND	K10	GND
GND	GND	K17	GND
GND	GND	L1	GND
GND	GND	L6	GND
GND	GND	L11	GND
GND	GND	L13	GND
GND	GND	L15	GND
GND	GND	L21	GND
GND	GND	L26	GND
GND	GND	M12	GND
GND	GND	M14	GND
GND	GND	M16	GND
GND	GND	N3	GND
GND	GND	N8	GND
GND	GND	N11	GND
GND	GND	N15	GND
GND	GND	P12	GND
GND	GND	P16	GND
GND	GND	P19	GND
GND	GND	P24	GND
GND	GND	R11	GND
GND	GND	R13	GND
GND	GND	R15	GND
GND	GND	T1	GND
GND	GND	T6	GND
GND	GND	T12	GND
GND	GND	T14	GND

## FG676 Footprint

### Left Half of FG676 Package (Top View)

**313** I/O: Unrestricted, general-purpose user I/O

**67** INPUT: Unrestricted, general-purpose input pin

**51** DUAL: Configuration pins, then possible user I/O

**2** SUSPEND: Dedicated SUSPEND and dual-purpose AWAKE Power Management pins

**38** VREF: User I/O or input voltage reference for bank

**32** CLK: User I/O, input, or clock buffer input

**2** CONFIG: Dedicated configuration pins

**4** JTAG: Dedicated JTAG port pins

**77** GND: Ground

**36** VCCO: Output voltage supply for bank

**23** VCCINT: Internal core supply voltage (+1.2V)

**14** VCCAUX: Auxiliary supply voltage

**17** N.C.: Not connected

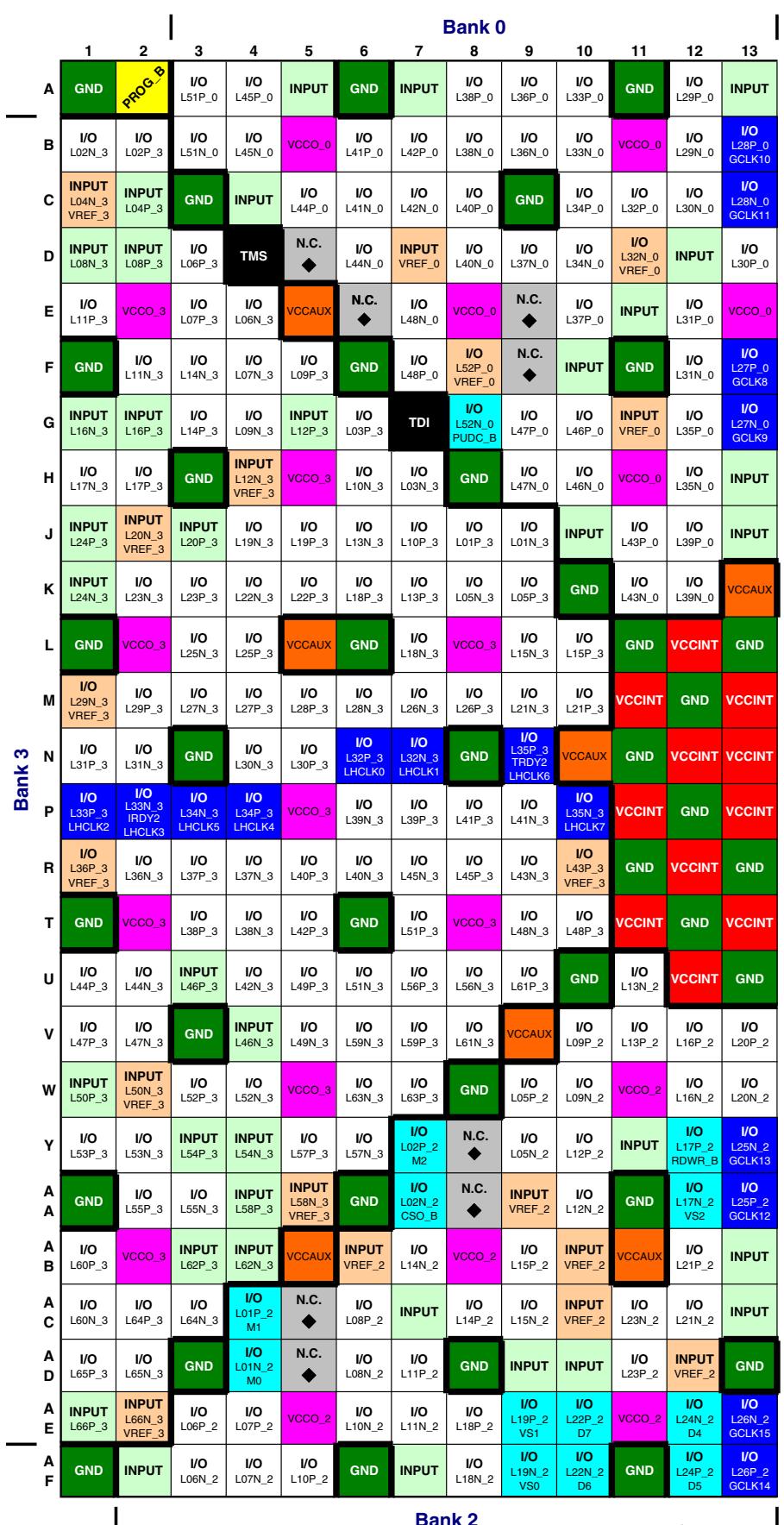


Figure 27: FG676 Package Footprint (Top View)

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Bank 0												
14	15	16	17	18	19	20	21	22	23	24	25	26
I/O L26N_0 GCLK7	I/O L23N_0	GND	INPUT	I/O L18N_0	I/O L15N_0	I/O L14N_0	GND	I/O L07N_0	INPUT	N.C. ◆	TCK	GND
I/O L26P_0 GCLK6	I/O L23P_0	VCCO_0	I/O L19N_0	I/O L18P_0	I/O L15P_0	I/O L14P_0 VREF_0	I/O L09N_0	VCCO_0	I/O L07P_0	N.C. ◆	INPUT L65N_1 VREF_1	INPUT L65P_1 VREF_1
GND	I/O L22N_0	I/O L21N_0	I/O L19P_0	I/O L17N_0	GND	I/O L11N_0	I/O L09P_0	I/O L05N_0	I/O L06N_0	GND	I/O L63N_1 A23	I/O L63P_1 A22
INPUT VREF_0	INPUT	I/O L22P_0	I/O L21P_0	I/O L17P_0	INPUT	I/O L11P_0	I/O L10N_0	I/O L05P_0	I/O L06P_0	I/O L61N_1	I/O L61P_1	I/O L60N_1
I/O L24P_0	I/O L20N_0 VREF_0	VCCAUX	I/O L13N_0	INPUT	VCCO_0	INPUT	I/O L10P_0	VCCAUX	TDO	I/O L56P_1	VCCO_1	I/O L60P_1
I/O L24N_0	I/O L20P_0	GND	I/O L13P_0	N.C. ◆	I/O L02N_0	I/O L01N_0	GND	I/O L58P_1 VREF_1	I/O L56N_1	I/O L54N_1	I/O L54P_1	GND
INPUT	I/O L16P_0	INPUT	I/O L08N_0	N.C. ◆	I/O L02P_0 VREF_0	I/O L01P_0	I/O L64N_1 A25	I/O L58N_1	I/O L51P_1	I/O L51N_1	INPUT L52N_1 VREF_1	INPUT L52P_1
GND	I/O L16N_0	VCCO_0	I/O L08P_0	INPUT	GND	I/O L64P_1 A24	I/O L62N_1 A21	VCCO_1	INPUT L48P_1	INPUT L48N_1	INPUT L44P_1	INPUT L44P_1 VREF_1
I/O L25N_0 GCLK5	INPUT	I/O L12P_0	INPUT VREF_0	VCCAUX	I/O L59P_1	I/O L59N_1	I/O L62P_1	I/O L49N_1	I/O L49P_1	GND	I/O L43N_1 A19	I/O L43P_1 A18
I/O L25P_0 GCLK4	VCCINT	I/O L12N_0	GND	I/O L57N_1	I/O L57P_1	I/O L53N_1	I/O L50N_1	I/O L46N_1	I/O L46P_1	INPUT L40P_1	I/O L41P_1	I/O L41N_1
VCCINT	GND	VCCINT	I/O L55N_1	I/O L55P_1	VCCO_1	I/O L53P_1	GND	I/O L50P_1	INPUT L40N_1	I/O L38P_1 A12	VCCO_1	GND
GND	VCCINT	GND	VCCINT	I/O L47N_1	I/O L47P_1	I/O L42N_1 A17	I/O L45P_1	I/O L45N_1	INPUT L38N_1 A13	INPUT L36P_1 VREF_1	I/O L35N_1 A11	I/O L35P_1 A10
VCCINT	GND	VCCINT	I/O L39N_1 A15	I/O L39P_1 A14	I/O L34N_1 RHCLK7	I/O L42P_1 A16	I/O L37N_1	VCCO_1	INPUT L36N_1	I/O L33N_1 RHCLK5	INPUT L32N_1	INPUT L32P_1
VCCINT	VCCINT	GND	VCCAUX	I/O L34P_1 IRDY1 RHCLK6	GND	I/O L30N_1 RHCLK1	I/O L30P_1 RHCLK0	I/O L37P_1	I/O L33P_1 RHCLK4	GND	I/O L31N_1 TRDY1 RHCLK3	I/O L31P_1 RHCLK2
VCCINT	GND	VCCINT	I/O L27N_1 A7	I/O L27P_1 A6	I/O L22P_1	I/O L22N_1	I/O L25P_1 A2	I/O L25N_1 A3	INPUT L28P_1 VREF_1	INPUT L28N_1	I/O L29P_1 A8	I/O L29N_1 A9
GND	VCCINT	GND	I/O L17N_1	I/O L17P_1	VCCO_1	I/O L14N_1	GND	VCCAUX	I/O L26P_1 A4	I/O L26N_1 A5	VCCO_1	GND
VCCAUX	I/O L35N_2	I/O L42N_2	GND	I/O L12N_1	I/O L12P_1	I/O L10N_1	I/O L14P_1	I/O L21N_1	I/O L23P_1	I/O L23N_1 VREF_1	INPUT L24P_1	INPUT L24N_1 VREF_1
I/O L31P_2	I/O L35P_2	I/O L42P_2	I/O L46N_2	I/O L08P_1	I/O L08N_1	SUSPEND	I/O L10P_1	I/O L18N_1	I/O L21P_1	I/O L19P_1	I/O L19N_1	INPUT L20N_1 VREF_1
GND	I/O L31N_2	VCCO_2	I/O L46P_2	N.C. ◆	GND	I/O L04P_1	I/O L04N_1	VCCO_1	I/O L18P_1	GND	INPUT L16P_1	INPUT L20P_1
I/O L27P_2 GCLK0	I/O L34N_2 D3	INPUT 2 VREF_2	I/O L43N_2	N.C. ◆	N.C. ◆	I/O L01P_1 HDC	I/O L01N_1 LDC2	I/O L13P_1	I/O L13N_1	I/O L15P_1	I/O L15N_1	INPUT L16N_1
I/O L27N_2 GCLK1	I/O L34P_2 INIT_B	GND	I/O L43P_2	I/O L47N_2	INPUT	INPUT VREF_2	GND	I/O L09P_1	I/O L09N_1	I/O L11P_1	I/O L11N_1	GND
VCCO_2	I/O L30N_2 MOSI CSI_B	I/O L38N_2	INPUT	I/O L47P_2	VCCO_2	INPUT	DONE	VCCAUX	I/O L07P_1	I/O L07N_1 VREF_1	VCCO_1	I/O L06N_1
I/O L29N_2	I/O L30P_2	I/O L38P_2	INPUT	INPUT	I/O L40N_2	I/O L41N_2	I/O L45N_2	N.C. ◆	I/O L03P_1 A0	I/O L03N_1 A1	I/O L05N_1	I/O L06P_1
I/O L29P_2	I/O L32P_2 AWAKE	INPUT	I/O L33N_2	GND	I/O L40P_2	I/O L41P_2	I/O L44N_2	I/O L45P_2	N.C. ◆	GND	I/O L02N_1 LDC0	I/O L05P_1
I/O L28N_2 GCLK3	I/O L32N_2 DOUT	VCCO_2	I/O L33P_2	I/O L36N_2 D1	I/O L37N_2	I/O L39N_2	I/O L44P_2	VCCO_2	I/O L48N_2	I/O L52N_2 CCLK	I/O L51N_2	I/O L02P_1 LDC1
I/O L28P_2 GCLK2	INPUT VREF_2	GND	INPUT VREF_2	I/O L36P_2 D2	I/O L37P_2	I/O L39P_2	GND	INPUT VREF_2	I/O L48P_2	I/O L52P_2 D0 DIN/MISO	I/O L51P_2	GND

Right Half of FG676 Package (Top View)

## Bank 2

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